## FAN5609

## LED Driver with Adaptive Charge Pump DC／DC Converter

## Features

－Parallel LED Driver Supports All Forward Voltages
－Adaptive Vout Adjustment to the Highest Diode Voltage
－Internally Matched LED Current Sources
－No External Components Needed to Set LED Current
－Built－in Charge Pump has Three Modes of Operation：
－Linear Regulation VIN $>4.2 \mathrm{~V}$
－3／2 DC－DC Converter and Regulation 3．6V $<V_{\text {IN }}<4.2 \mathrm{~V}$
－2／1 DC－DC Converter and Regulation $2.7 \mathrm{~V}<\mathrm{V}_{\text {IN }}<3.6 \mathrm{~V}$
－Up to $86 \%$ Efficiency
－Low EMI，Low Ripple
－Up to 80 mA Output Current $(4 \times 20 \mathrm{~mA})$
－Built－in DAC for Digital or PWM Brightness Control
－Can be Duty Cycle Modulated between 0 to 18 mA
－2．7V to 5．5V Input Voltage Range
－ICC $<2 \mu \mathrm{~A}$ in Shutdown Mode
－ 1 MHz Operating Frequency
－Shutdown Isolates Output from Input
－Soft－Start Limits Inrush Current
－Short Circuit Protection
－Minimal External Components Needed
－Available in a 14－lead TSSOP Package
－Available in a 16－lead MLP Package

## Applications

－Cell Phones
－Handheld Computers
－PDA，DSC，MP3 Players
－Keyboard Backlight
－LED Displays

## Description

The FAN5609 generates regulated output current from a battery with input voltage varying between 2.7 V to 5.5 V ． Switch reconfiguration and fractional switching techniques are utilized to achieve high efficiency over the entire input voltage range．A proprietary internal circuitry continuously monitors each LED current loop and automatically adjusts the generated output DC voltage to the lowest minimum value required by the LED having the highest forward voltage．This adaptive nature of the FAN5609 eliminates the need for LED pre－selection（matching）and ensures opera－ tion at high efficiency．When the input voltage is sufficiently high to sustain the programmed current level in the LEDs， the FAN5609 re－configures itself to operate as a linear regulator，and the DC－DC converter is turned off．An internal two－bit digital to analog converter provides programmability of the output currents．Only two $0.1 \mu \mathrm{~F}$ bucket capacitors and two $4.7 \mu \mathrm{~F}$ input／output capacitors are needed for proper operation．

Soft－start circuitry prevents excessive current draw during power on．The device has built－in short circuit protection．

## Typical Application



## Pin Assignments



## Pin Descriptions

| Pin No. | FAN5609 |  | Pin Function Description |
| :---: | :---: | :---: | :--- |
|  | 14L-TSSOP | 4mmX4mm 16L-MLP |  |
| 1 | VIN | Input |  |
| 2 | VOUT | VOUT | Output to LEDs Anode |
| 3 | GND | GND | Ground |
| 4 | B | B | DAC B |
| 5 | A | A | DAC A |
| 6 | LED - | LED - | 4th LED Cathode |
| 7 | LED - | LED - | 3rd LED Cathode |
| 8 | LED - | LED - | 2nd LED Cathode |
| 9 | LED - | LED - | 1st LED Cathode |
| 10 | NC | NC | No Connection |
| 11 | CAP1- | CAP1- | Bucket capacitor negative terminal |
| 12 | CAP1+ | CAP1+ | Bucket capacitor positive connection |
| 13 | CAP2+ | CAP2+ | Bucket capacitor positive terminal |
| 14 | CAP2- | CAP2- | Bucket capacitor negative connection |
| 15 |  | NC | No Connection |
| 16 |  | NC | No Connection |

## Test Circuit



All capacitors are Ceramic chip capacitor

## Absolute Maximum Ratings

| Parameter | Min | Max | Unit |
| :--- | :---: | :---: | :---: |
| VIN, Vout, A, B Voltage to GND | -0.3 | 6.0 | V |
| CAP+, CAP-, to GND | -0.3 | VIN $^{2} 0.3$ | V |
| Vout Short Circuit Duration |  | INDEFINITE |  |
| Lead Soldering Temperature (10 seconds) |  | 300 | ${ }^{\circ} \mathrm{C}$ |
| Operating Junction Temperature Range |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -55 | 150 | ${ }^{\circ} \mathrm{C}$ |
| Electrostatic Discharge Protection Level (Note 1) | HBM | 4 |  |
|  | kV |  |  |

## Recommended Operating Conditions

| Parameter | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Input Voltage Range, $\mathrm{V}_{\text {IN }}$ | 2.7 |  | 5.5 | V |
| Operating Ambient Temperature Range | -40 | 25 | 85 | ${ }^{\circ} \mathrm{C}$ |

## DC Electrical Characteristics

Unless otherwise noted, V IN $=3 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. Refer to "Test Circuit". Boldface values indicate specifications over the ambient operating temperature range.

| Parameter | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Quiescent Current | $\begin{gathered} \hline \text { Vout }=5.5 \mathrm{~V}, \\ \text { No Load } \end{gathered}$ |  | 1.5 | 4 | mA |
| Output Current Accuracy $\mathrm{I}_{\mathrm{NOM}}=20 \mathrm{~mA}$ | $\begin{aligned} & \mathrm{A}=\mathrm{High} \\ & \mathrm{~B}=\mathrm{High} \end{aligned}$ | 17 | 20 | 23 | mA |
| LED to LED Current Matching | $\begin{gathered} \mathrm{VIN}=5.5 \mathrm{~V} \\ \mathrm{~A}=\mathrm{B}=\mathrm{High} \end{gathered}$ | -5 |  | +5 | \% |
| Efficiency | V IN $=4.5 \mathrm{~V}$ |  | 85 to75 |  | \% |
|  | V IN $=3 \mathrm{~V}$ |  | 65 to 55 |  |  |
| Input A, B Threshold | Low | 0 |  | $0.3 \times \mathrm{V}_{\text {IN }}$ | V |
|  | High | $0.6 \times$ VIN |  | VIN |  |
| $V_{\text {IN }}$ at Configuration Change | From 1:1 to 3:2 |  | 4.2 |  | V |
|  | From 3:2 to 2:1 |  | 3.6 |  |  |
| Oscillator Frequency |  | 0.80 | 1 | 1.2 | MHz |
| Supply Current, "OFF Mode" |  |  |  | 2 | $\mu \mathrm{A}$ |

## Note:

1. Using Mil Std. 883E, method 3015.7(Human Body Model) and EIA/JESD22C101-A (Charge Device Model)

## Block Diagram



## Circuit Description

The FAN5609's switched capacitor DC/DC converter automatically configures its internal switches to achieve high efficiency and to provide tightly regulated output currents for the LEDs. An analog detector determines which diode requires the highest voltage in order to sustain the pre-set current levels, and adjusts the pump regulator accordingly. Every diode has its own linear current regulator. In addition, a voltage regulator controls the output voltage when the battery voltage is within a range where linear regulation can provide maximum possible efficiency. If the battery voltage is too low to sustain the diode current in the linear mode, a fractional 3:2 charge pump is enabled. When the battery voltage drops further and this mode is no longer sufficient to sustain proper operation, the pump is automatically reconfigured to operate in $2: 1$ mode. As the battery discharges and
the voltage decays, the FAN5609 switches between modes to maintain a constant current through LED throughout the battery life. The transition has hysteresis to prevent toggling.

## Supply Voltage

The internal supply voltage for the device is automatically selected from VIN or Vout pins, whichever is higher.

## Soft Start

The soft-start circuit limits inrush current when the device is initially powered up and enabled. The reference voltage controls the rate of the output voltage ramp-up to its final value. Typical start-up time is 1 ms . The rate of the output voltage ramp-up is controlled by an internally generated slow ramp, and an internal variable resistor limits the input current.

## Switch Configuration



Figure 1
Step-up, 2:1 configuration.
Switch positions shown in charge phase.
Reverse all switches for pump phase

## Shutdown and Short Circuit Current Limit

Set both DAC inputs low to shut down the device. Built-in short circuit protection limits the supply current to a maximum of 50 mA .

## Digital Control

A digital-to-analog converter (DAC) allows selection of the following modes: OFF, $7 \mathrm{~mA}, 14 \mathrm{~mA}, 20 \mathrm{~mA}$, per diode. By turning the IN B pin ON and OFF, the current can be modulated between 7 to 20 mA to achieve any $\mathrm{I}_{\text {Average }}$ value (PWM). In PWM mode, the modulating frequency has to be set sufficiently high in order to avoid a flickering effect ( 100 Hz to 1 kHz ).

| A | 0 | 1 | 0 | 1 |
| :---: | :---: | :---: | :---: | :---: |
| B | 0 | 0 | 1 | 1 |
| ILED | OFF | 7 mA | 14 mA | 20 mA |



Figure 2
3:2 configuration
Switch positions shown in charge phase
Reverse all switches for pump phase.

## Digital Control with PWM

Any input can be modulated by a pulse train of variable duty cycle ( $\delta$ ). By turning ON and OFF DAC inputs A or B, the current can be continuously modulated to any average value between 1 to 19 mA . For a maximum range of LED current, both A\&B can be modulated at the same time.

## Digital Control with PWM

A is PWM and B is Low. ILED (Average) $=\delta \times 7 \mathrm{~mA}$, where $\delta$ is Duty Cycle. (Note 2)


A is High and B is PWM. ILed (Average) $=6 \mathrm{~mA}+\delta \times 12 \mathrm{~mA}$, where $\delta$ is Duty Cycle. (Note 3, 4)


## Notes:

2. Proportionally select the duty cycle to achieve a typical LED current between 1 mA to 6 mA .
3. If either input $A$ or $B$ is continuously high, the other input can be modulated at a maximum rate of 30 kHz . Otherwise the maximum rate of modulation should be limited to 1 kHz .
4. Proportionally select the duty cycle to achieve a typical LED current between 8 mA to 19 mA .

## Digital Control with PWM (Continued)

A and B are PWM. ILED (Average) $=\delta \times 20 \mathrm{~mA}$, where $\delta$ is Duty Cycle. $($ Note 3, 5)


Notes:
5. Proportionally select the duty cycle to achieve a typical LED current between 1 mA to 19 mA .

## Application Information

## Selecting Capacitors

It is important to select the appropriate capacitor types and the values for use with the FAN5609. These capacitors determine parameters such as power efficiency, maximum sustainable load current by the charge pump, input and output ripple and start-up time.

In order to reduce ripple, both CIN and Cout should be low ESR capacitor. Increasing the Cout capacitor reduces the output ripple voltage. However this will increase the power-on time. The CIN value controls input ripple. If necessary, this ripple can be further reduced by powering the FAN5609 through a very small series inductor filter, as shown in Figure 3.


CAP1 and CAP2 control the current capability of the charge pump and affect the overall efficiency of the system. A lower value will improve efficiency, but it may limit the LED's currents at low input voltage. A capacitor of 100 nF is optimal for $4 \times 20 \mathrm{~mA}$ load over the entire input voltage range of 2.7 V to 4.2 V . To save space and cost, and to increase efficiency, this value may be reduced to 10 nF for loads less than $4 \times 7 \mathrm{~mA}$.

## Pulse-Width-Modulated (PWM) Mode

Conversion errors are minimized and the best LED to LED matching is achieved over the entire range of average current settings, when PWM brightness control is used to modulate the LED current between zero and the maximum value ( $\mathrm{A}=1, \mathrm{~B}=1$ ).

## PC Board Layout

For best performance, a solid ground plane is recommended on the back side of the PCB. The ground tails of $\mathrm{C}_{\mathrm{IN}}$ and Cout should be connected together close to the GND pin of IC.

Figure 3.

## Typical Performance Characteristics

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{IN}}=$ Cout $=4.7 \mu \mathrm{~F}, \mathrm{CAP} 1=\mathrm{CAP} 2=0.1 \mu \mathrm{~F}$, using Fairchild's QTLP670C-IW Super Bright LED.


Supply Current vs Input Voltage (4 LEDs)


Efficiency vs Input Voltage
(4 LEDs x 20mA)


DAC Threshold Voltage vs
Input Voltage



## Mechanical Dimensions 14-Lead TSSOP Package



## Mechanical Dimensions <br> 4mmX4mm 16-Lead MLP Package



## Ordering Information

| Product Number | Package Type | Order Code |
| :---: | :---: | :---: |
| FAN5609 | 14-Lead TSSOP | FAN5609MTCX |
|  | $4 m m \times 4 m m$ 16-Lead MLP | FAN5609MPX |

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.
